



BAV99QB

Dual series high-speed switching diodes

13 February 2024

Product data sheet

1. General description

Dual series high-speed switching diodes, encapsulated in an ultra small DFN1110D-3 (SOT8015, JEDEC MO340-BA) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

2. Features and benefits

- High switching speed: $t_{rr} \leq 4$ ns
- Low leakage current
- Reverse voltage $V_R \leq 90$ V
- Low capacitance $C_d \leq 2$ pF
- Ultra small SMD plastic package
- Low package height of 0.5 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint

3. Applications

- High-speed switching
- General-purpose switching
- Reverse polarity protection

4. Quick reference data

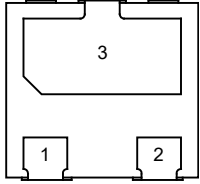
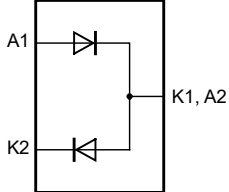
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Per diode							
I_F	forward current	single diode loaded; $T_{amb} = 25$ °C	[1]	-	-	300	mA
V_R	reverse voltage	$T_j = 25$ °C		-	-	90	V
I_R	reverse current	$V_R = 80$ V; $T_j = 25$ °C		-	-	0.5	µA
t_{rr}	reverse recovery time	$I_F = 10$ mA; $I_R = 10$ mA; $I_{R(meas)} = 1$ mA; $R_L = 100$ Ω; $T_{amb} = 25$ °C		-	-	4	ns

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode (diode 1)	 <p>Transparent top view DFN1110D-3 (SOT8015)</p>	 <p>aaa-022858</p>
2	K2	cathode (diode 2)		
3	K1, A2	cathode (diode 1) and anode (diode 2)		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAV99QB	DFN1110D-3	plastic, leadless extremely thin small outline package with side-wettable flanks (SWF); 3 terminals; 0.65 mm pitch; 1.1 mm x 1 mm x 0.48 mm body	SOT8015

7. Marking

Table 4. Marking codes

Type number	Marking code
BAV99QB	G6

8. Limiting values

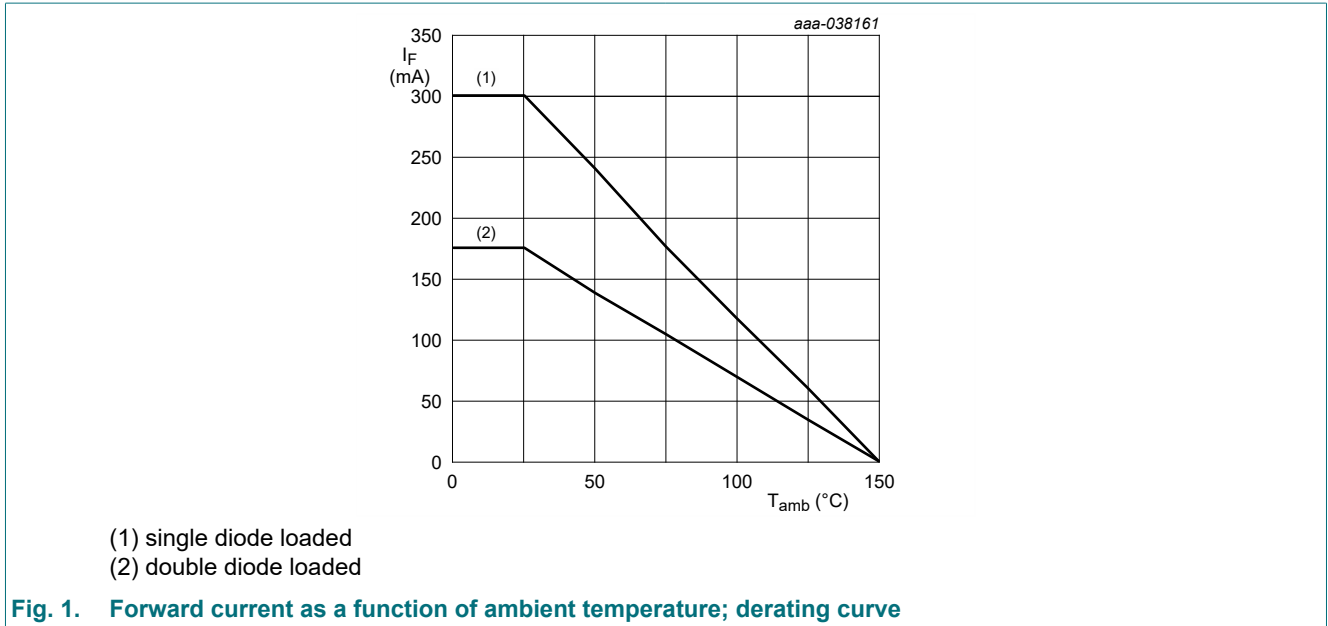
Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per diode						
V_R	reverse voltage	$T_j = 25\text{ °C}$		-	90	V
I_F	forward current	single diode loaded; $T_{amb} = 25\text{ °C}$	[1]	-	300	mA
		double diode loaded; $T_{amb} = 25\text{ °C}$	[1]	-	175	mA
I_{FRM}	repetitive peak forward current	$t_p \leq 0.5\text{ ms}$; $\delta \leq 0.25$; $T_j = 25\text{ °C}$		-	1000	mA
I_{FSM}	non-repetitive peak forward current	$t_p = 100\text{ }\mu\text{s}$; square wave; $T_{j(\text{init})} = 25\text{ °C}$		-	4.7	A
		$t_p = 1\text{ ms}$; square wave; $T_{j(\text{init})} = 25\text{ °C}$		-	2.4	A
		$t_p = 10\text{ ms}$; square wave; $T_{j(\text{init})} = 25\text{ °C}$		-	1.5	A
Per device; one diode loaded						
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	390	mW
			[2]	-	625	mW
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-55	150	°C
T_{stg}	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².



9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	[1]	-	-	320	K/W
		[2]	-	-	200	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point	[3]	-	-	40	K/W

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [3] Soldering point of cathode tab.

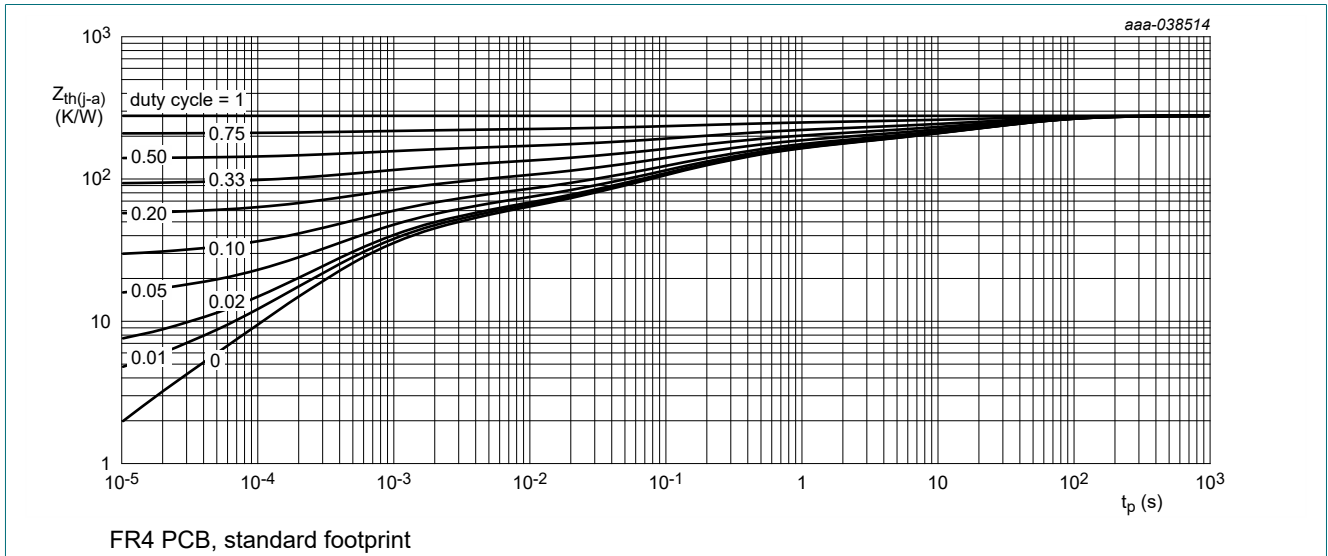


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

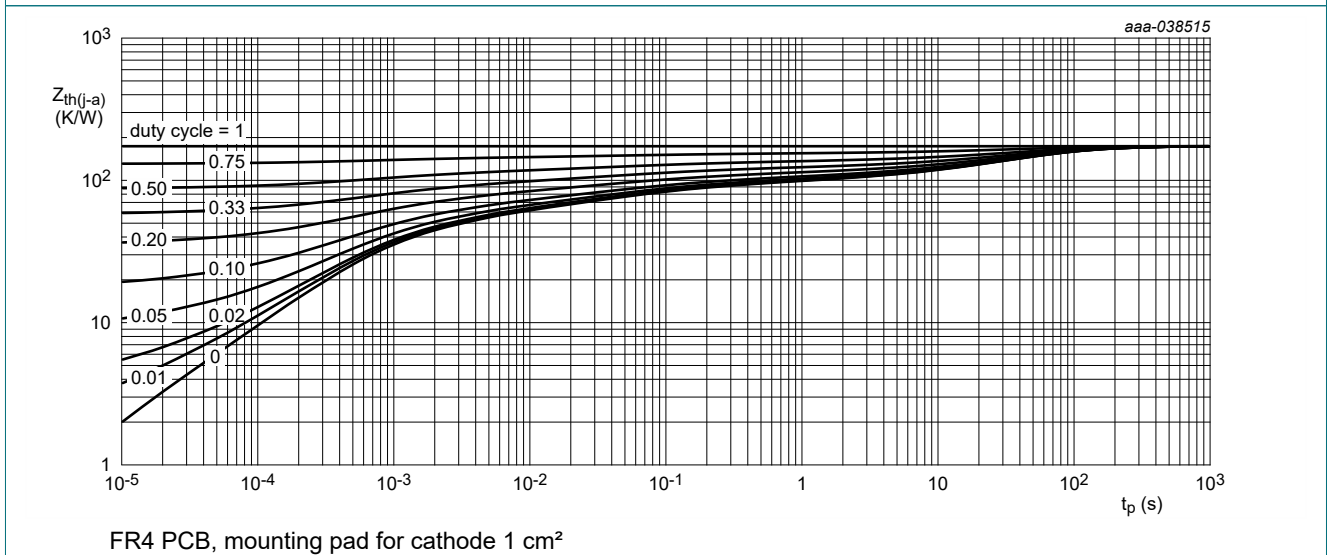
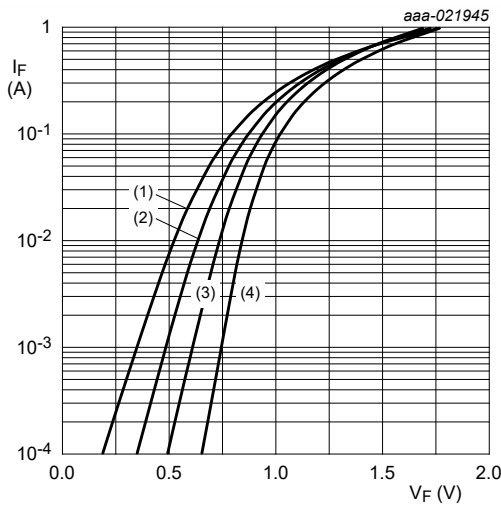


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

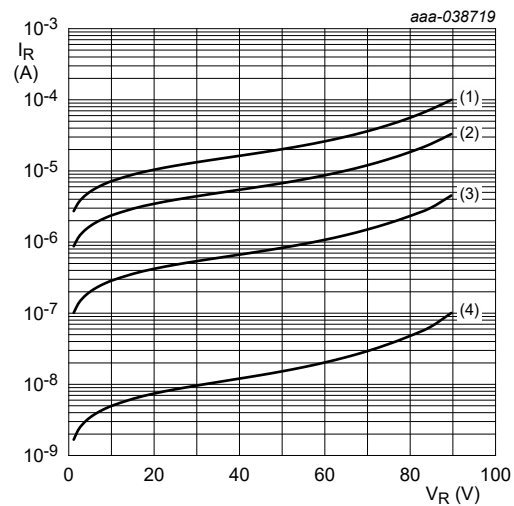
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Per diode						
V_F	forward voltage	$I_F = 1 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$	-	-	715	mV
		$I_F = 10 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$	-	-	855	mV
		$I_F = 50 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$	-	-	1	V
		$I_F = 150 \text{ mA}; T_j = 25 \text{ }^\circ\text{C}$	-	-	1.25	V
I_R	reverse current	$V_R = 25 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	-	30	nA
		$V_R = 80 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	-	0.5	μA
		$V_R = 25 \text{ V}; T_j = 150 \text{ }^\circ\text{C}$	-	-	30	μA
		$V_R = 80 \text{ V}; T_j = 150 \text{ }^\circ\text{C}$	-	-	150	μA
C_d	diode capacitance	$V_R = 0 \text{ V}; f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	2	pF
t_{rr}	reverse recovery time	$I_F = 10 \text{ mA}; I_R = 10 \text{ mA}; I_{R(\text{meas})} = 1 \text{ mA}; R_L = 100 \text{ } \Omega; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	4	ns
V_{FRM}	peak forward recovery voltage	$I_F = 10 \text{ mA}; t_r = 20 \text{ ns}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$	-	-	1.75	V



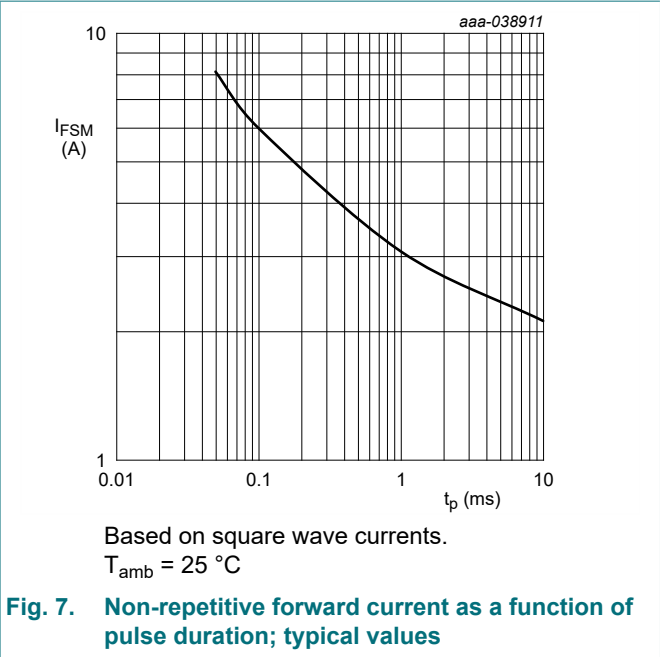
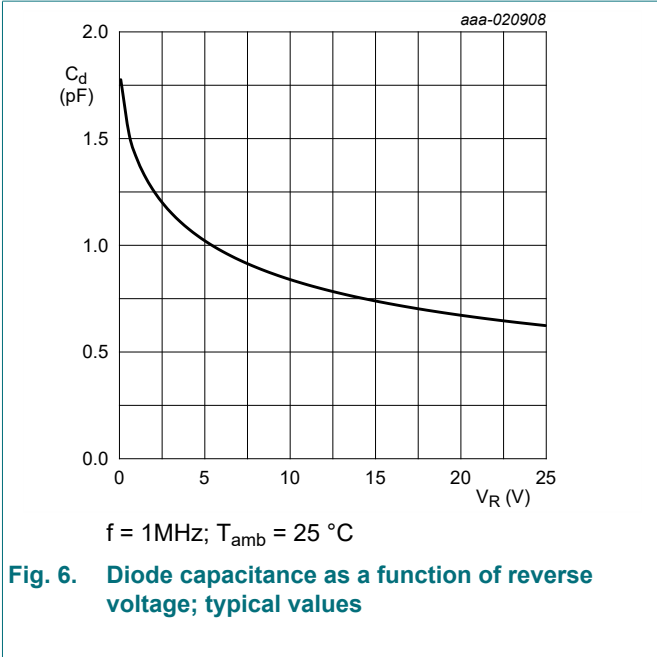
- (1) $T_j = 150 \text{ }^\circ\text{C}$
- (2) $T_j = 85 \text{ }^\circ\text{C}$
- (3) $T_j = 25 \text{ }^\circ\text{C}$
- (4) $T_j = -40 \text{ }^\circ\text{C}$

Fig. 4. Forward current as a function of forward voltage; typical values



- (1) $T_j = 150 \text{ }^\circ\text{C}$
- (2) $T_j = 125 \text{ }^\circ\text{C}$
- (3) $T_j = 85 \text{ }^\circ\text{C}$
- (4) $T_j = 25 \text{ }^\circ\text{C}$

Fig. 5. Reverse current as a function of reverse voltage; typical values



11. Test information

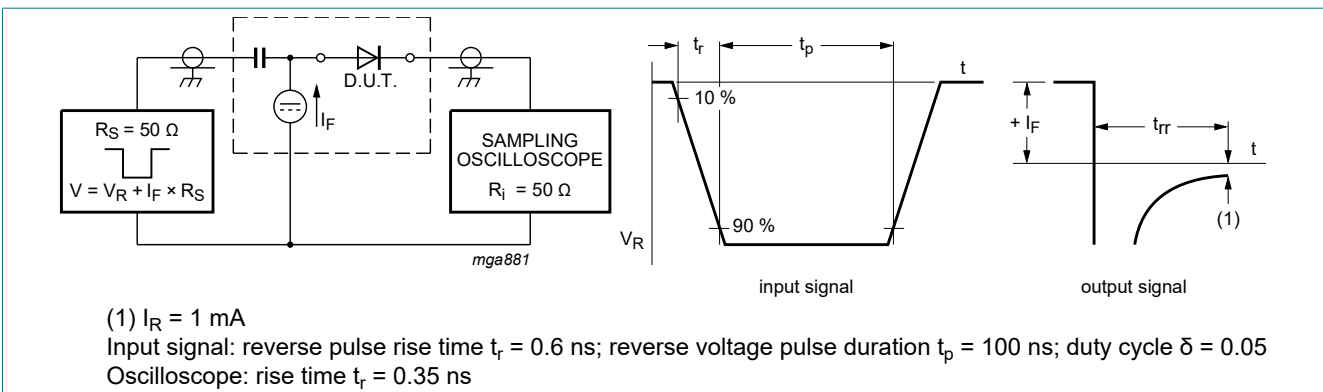


Fig. 8. Reverse recovery time test circuit and waveforms

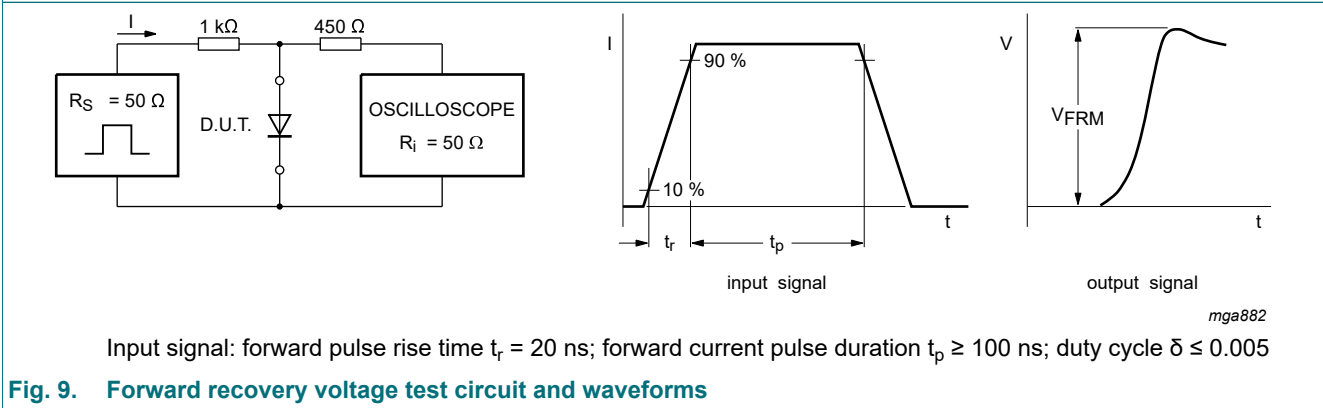


Fig. 9. Forward recovery voltage test circuit and waveforms

12. Package outline

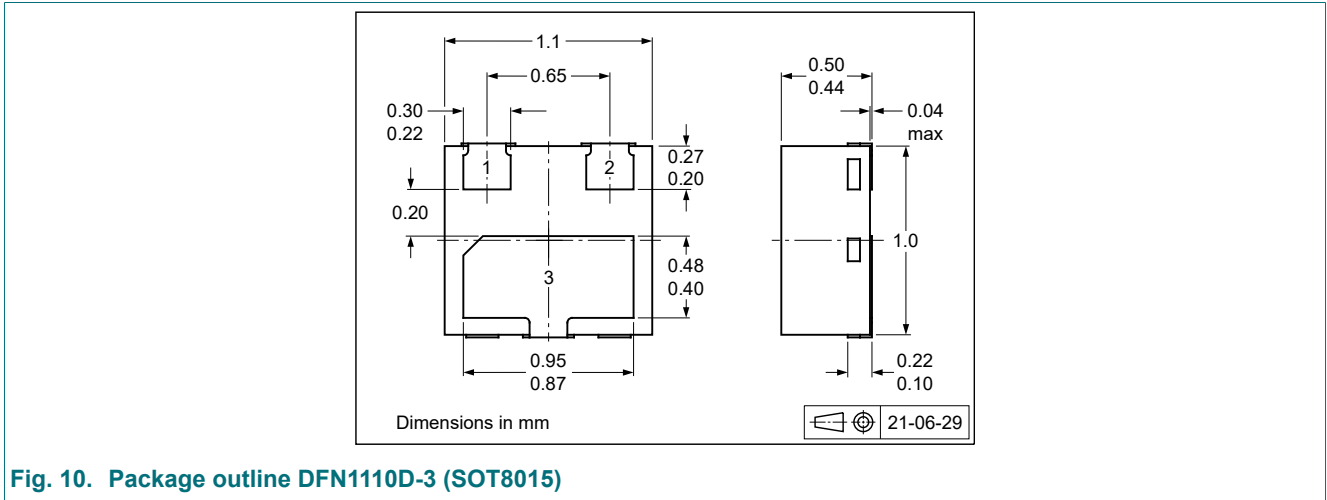


Fig. 10. Package outline DFN1110D-3 (SOT8015)

13. Soldering

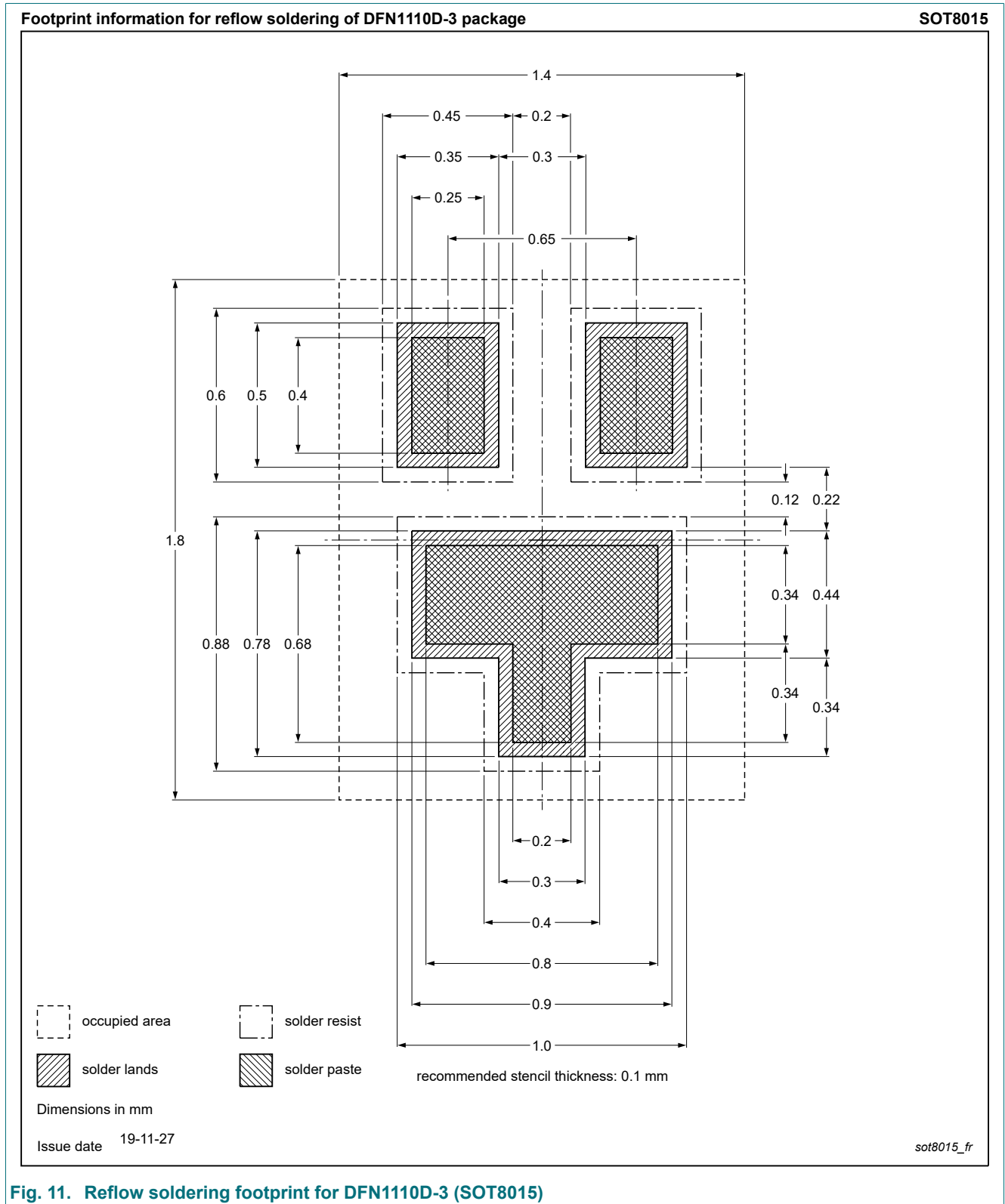


Fig. 11. Reflow soldering footprint for DFN1110D-3 (SOT8015)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAV99QB v.1	20240213	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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